

1 dB LSB GaAs IC 5-BIT DIGITAL ATTENUATOR, 0.7 - 2.7 GHz



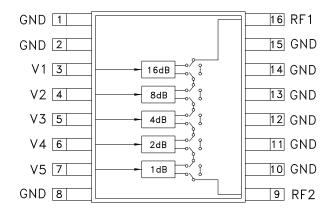


Typical Applications

The HMC274QS16 / HMC274QS16E is ideal for:

- Cellular/PCS/3G Infrastructure
- 2.4 GHz ISM Radios
- Wireless Data

Functional Diagram



Features

1 dB LSB Steps to 31 dB
Single Positive Control (+3 to +5V) Per Bit
±0.5 dB Typical Bit Error
Small QSOP16 Plastic Package
Included in the HMC-DK004 Designer's Kit

General Description

The HMC274QS16 & HMC274QS16E are broadband 5-bit positive control GaAs IC digital attenuators in 16 lead QSOP plastic packages. Covering 0.7 to 2.7 GHz the insertion loss is typically less than 2.3 dB. The attenuator bit values are 1 (LSB), 2, 4, 8, and 16 dB for a total attenuation of 31 dB. Accuracy is excellent at ± 0.5 dB typical with an IIP3 of up to +50 dBm. Five bit control voltage inputs, toggled between 0 and +3 to +5 volts, are used to select each attenuation state. A single Vdd bias of +3 to +5 volts applied through an external 5K Ohm resistor is required.

Electrical Specifications, $T_A = +25^{\circ}$ C, Vdd = +3V to +5V & Vctl = 0/Vdd

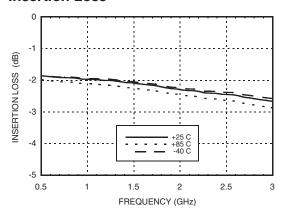
Parameter		Frequency	Min.	Typical	Max.	Units
Insertion Loss		0.7 - 1.4 GHz 1.4 - 2.3 GHz 2.3 - 2.7 GHz		2.0 2.3 2.5	2.4 2.7 3.1	dB dB dB
Attenuation Range		0.7 - 2.7 GHz		31		dB
Return Loss (RF1 & RF2, All Atten. States)		0.7 - 1.4 GHz 1.4 - 2.7 GHz	10 12	15 17		dB dB
Attenuation Accuracy: (Referenced to Insertion Loss)						
All Attenuation States All Attenuation States All Attenuation States		0.7 - 1.4 GHz 1.4 - 2.3 GHz 2.3 - 2.7 GHz	\pm 0.35 + 5% of Atten. Setting Max \pm 0.25 + 3% of Atten. Setting Max \pm 0.30 + 5% of Atten. Setting Max		dB dB dB	
Input Power for 0.1 dB Compression	Vdd = 5V Vdd = 3V	0.7 - 2.7 GHz		29 20		dBm dBm
Input Third Order Intercept Point (Two-tone Input Power = 0 dBm Each Tone)	Vdd = 5V Vdd = 3V	0.7 - 2.7 GHz		54 52		dBm dBm
Switching Characteristics						
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)		0.7 - 2.7 GHz		560 600		ns ns



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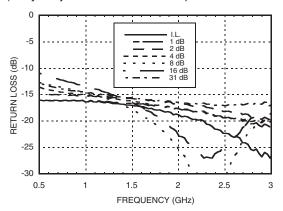


Insertion Loss



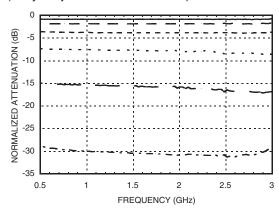
Return Loss RF1, RF2

(Only Major States are Shown)

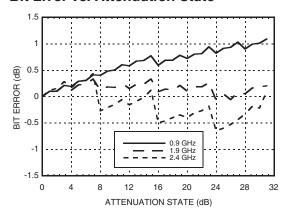


Normalized Attenuation

(Only Major States are Shown)

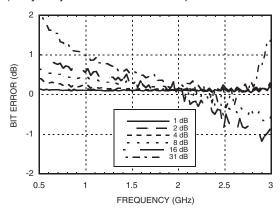


Bit Error vs. Attenuation State



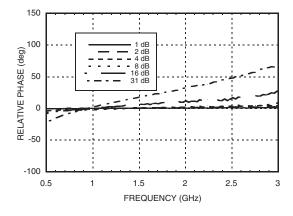
Bit Error vs. Frequency

(Only Major States are Shown)



Relative Phase vs. Frequency

(Only Major States are Shown)



Note: All Data Typical Over Voltage (+3V to +5V).

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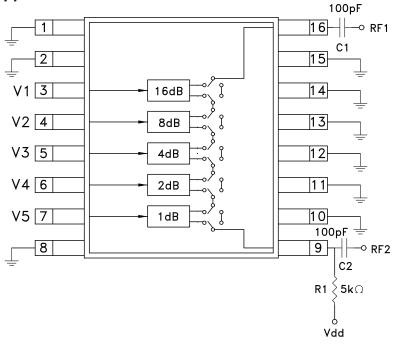
HMC274QS16 / 274QS16E

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Compression Point & IP3

Attenuation Control		Inp	Input P1dB (dBm)		Input P0.1dB (dBm)			Input IP3 (dBm)		
State (dB)	Voltage (V)	+25C	+85C	-40C	+25C	+85C	-40C	+25C	+85C	-40C
1	5	32.3	31.8	32.9	29.4	28.8	29.8	54.7	49.1	52.2
2	5	32.3	31.8	32.8	29.2	28.6	29.4	52.2	49.1	52.2
4	5	32.8	32.1	33.3	29.4	28.7	29.3	54.1	48.65	52.7
1	3	24.8	25.7	25.2	19.7	18.6	21.1	52.2	48.1	52.5
2	3	24.7	24.1	25.1	19.7	18.3	21.0	52.2	48.1	52.2
4	3	26.0	25.6	26.6	19.6	18.6	21.1	53.1	47.65	53.2

Application Circuit



DC blocking capacitors C1 & C2 are required on RF1 & RF2. Choose C1 = C2 = $100 \sim 300$ pF to allow lowest customer specific frequency to pass with minimal loss. R1 = 5K Ohm is required to supply voltage to the circuit through either PIN 9 or PIN 16.

Truth Table

		Attenuation			
V1 16 dB	V2 8 dB	V3 4 dB	V4 2 dB	V5 1 dB	Setting RF1 - RF2
High	High	High	High	High	Reference I.L.
High	High	High	High	Low	1 dB
High	High	High	Low	High	2 dB
High	High	Low	High	High	4 dB
High	Low	High	High	High	8 dB
Low	High	High	High	High	16 dB
Low	Low	Low	Low	Low	31 dB Max. Atten.
Any combination of	Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.				



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Absolute Maximum Ratings

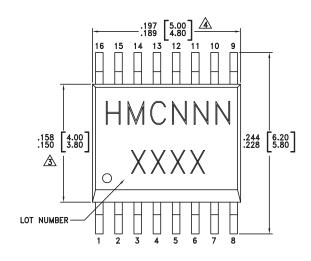
Control Voltage (V1 - V5)	Vdd + 0.5 Vdc
Bias Voltage (Vdd)	+8.0 Vdc
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
RF Input Power (0.7 - 2.7 GHz)	+30 dBm

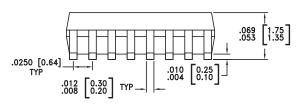


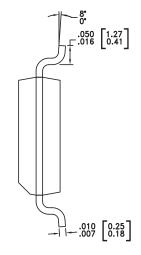
Control Voltages

State	Bias Condition	
Low	0 to +0.2 V @ 20 uA Max	
High	Vdd ± 0.2V @ 100 uA Max	
Note: $Vdd = +3V$ to $5V \pm 0.2V$		

Outline Drawing







NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC274QS16	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	HMC274 XXXX
HMC274QS16E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	HMC274 XXXX

- [1] Max peak reflow temperature of 235 $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX



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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 2, 8, 10 - 15	GND	This pin must be DC grounded.	GND =
3 - 7	V1 - V5	See truth table and control voltage table.	
9	RF1	This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required.	RF10—
16	RF1	This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required.	

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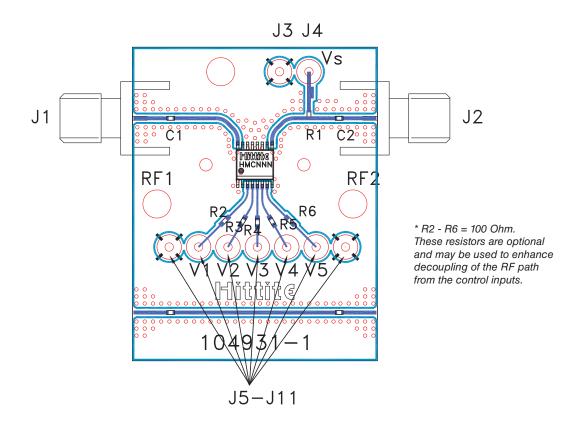
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Evaluation PCB



List of Materials for Evaluation PCB 104976 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3 - J11	DC Pin
R1	5k Ohm Resistor, 0402 Chip
R2 - R6	100 Ohm Resistor, 0402 Chip
C1, C2	0402 Chip Capacitor, Select for Lowest Frequency of Operation
U1	HMC274QS16 / HMC274QS16E Digital Attenuator
PCB [2]	104931 Evaluation PCB

^[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown below. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board as shown is available from Hittite Microwave Corporation upon request.